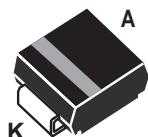


## Surface Mount Fast Recovery Rectifier

**ES3JB**

**SMB**



**Cathode** o  **Anode**

**Marking:ES3J**

### Features

- Low forward voltage drop
- Low leakage current
- High current capability
- Super fast switching speed
- High forward surge capability
- High reliability.

### Mechanical Data

- Epoxy: UL 94V-O rate flame retardant
- Lead: lead solderable per MIL-STD-202, method 208 guaranteed
- Polarity: Color band denotes cathode end

### ■ Maximum Ratings (Ta=25°C Unless otherwise specified)

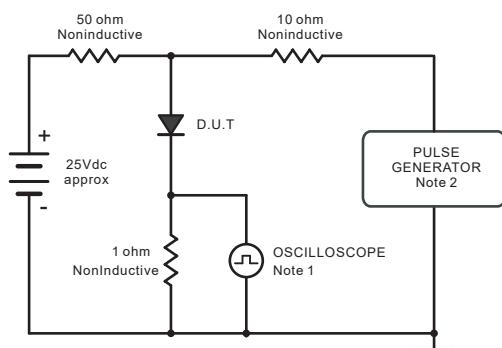
Parameter	Symbols	ES3JB	Units
Maximum Repetitive Peak Reverse Voltage	VRRM	600	V
Maximum RMS voltage	VRMS	420	V
Maximum DC Blocking Voltage	VDC	600	V
Maximum Average Forward Rectified Current	I(AV)	3.0	A
Reverse Recovery Time, IF=0.5A,IR=1A,IRR=0.25A	Trr	35	ns
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	IFSM	105	A
I <sup>2</sup> t rating for fusing ( 1ms < t < 8.3ms)	I <sup>2</sup> t	33.6	A <sup>2</sup> S
Maximum Forward Voltage at 3.0A and 25°C	VF	1.7	V
Maximum DC Reverse Current @TA=25 °C at Rated DC Blocking Voltage @TA=100 °C	IR	5 100	µA
Typical Junction Capacitance (Note1)	C <sub>j</sub>	45	pF
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-55 ~ +150	°C
Typical thermal resistance (Note 2)	R <sub>θJ-C</sub>	16	°C/W

Note: 1. Measured at 1MHz and applied reverse voltage of 4 VDC.

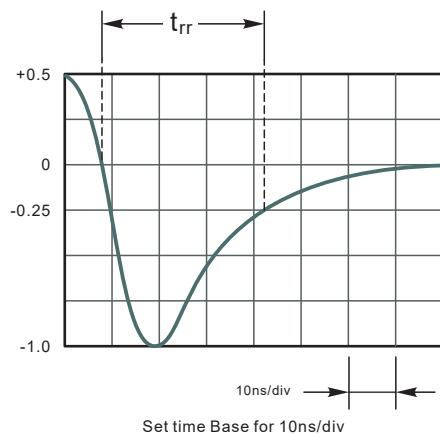
2. Thermal resistance between junction and ambient and between junction and lead mounted on P.C.B with  
3mm\*3mm copper pad areas.

## RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

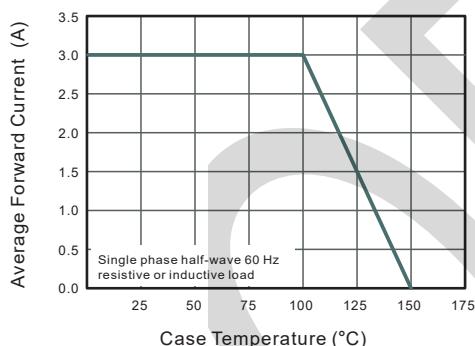
**Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram**



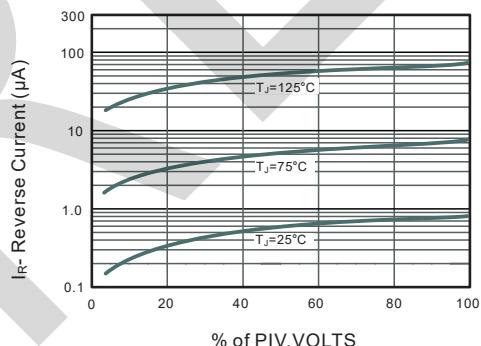
Note: 1. Rise Time = 7ns, max.  
 Input Impedance = 1megohm,22pF.  
 2. Ries Time =10ns, max.  
 Source Impedance = 50 ohms.



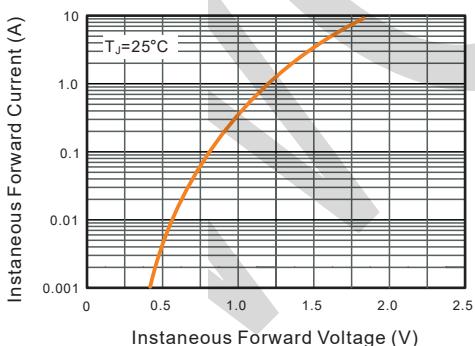
**Fig.2 Maximum Average Forward Current Rating**



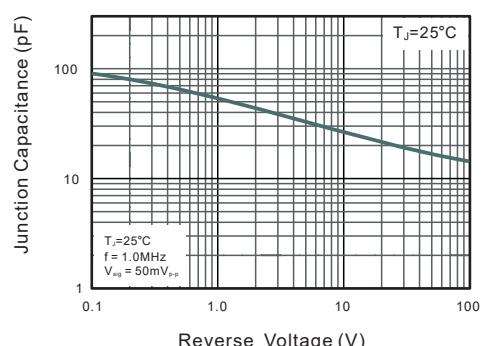
**Fig.3 Typical Reverse Characteristics**



**Fig.4 Typical Forward Characteristics**

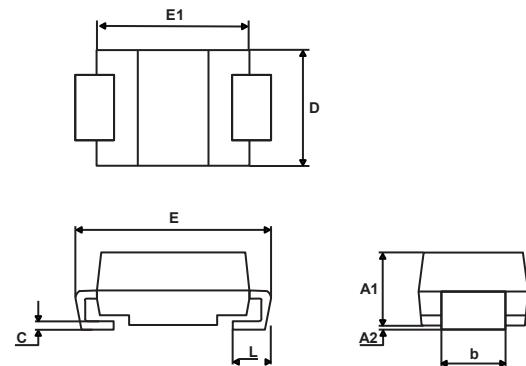


**Fig.5 Typical Junction Capacitance**



## PACKAGE OUTLINE DIMENSIONS

### SMB dimension definitions



### SMB dimension values

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
c	0.15	0.40	0.006	0.016
D	3.30	3.95	0.130	0.156
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
L	0.75	1.50	0.030	0.059